

Mobile DiskOnChip 16MB**9x11 mm BGA Package****Description**

M-Systems is announcing the End of Life (EOL) of the following DiskOnChip product:

EOL Product		Recommended Replacement	
Product Name	Ordering Info	Product Name	Ordering Info
Mobile DiskOnChip 16MB 63-ball, 9x11 mm BGA package Commercial and Extended temperature ranges	MD2212-D16-T	Mobile DiskOnChip Plus 16MB 69-ball, 9x12 mm BGA package Commercial and Extended temperature ranges	MD3831-D16- V3Q18-T

Reason for EOL

Mobile DiskOnChip 16MB is being replaced with Mobile DiskOnChip Plus 16MB, which provides advanced protection and security-enabling features, and additional interface and voltage options.

Schedule

Last order date: December 1, 2002

Last shipment date: February 1, 2003

Compatibility Issues

Please refer to the DiskOnChip migration guide for detailed information on migrating from Mobile DiskOnChip 16MB to Mobile DiskOnChip Plus 16MB.

Call for Action

Customers using the above product are requested to evaluate Mobile DiskOnChip Plus 16MB.

How to Contact Us

Please contact your M-Systems representative or visit our website (www.m-sys.com) for any further information or assistance.

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